

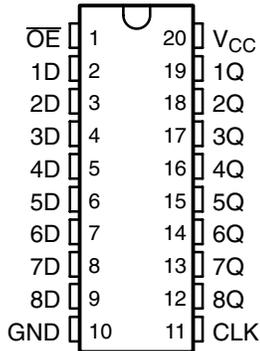
# SN54BCT574, SN74BCT574 OCTAL TRANSPARENT D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCBS074C – SEPTEMBER 1991 – REVISED MARCH 2003

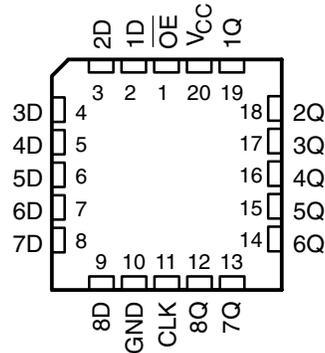
- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces  $I_{CCZ}$
- Full Parallel Access for Loading

- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

SN54BCT574 . . . J OR W PACKAGE  
SN74BCT574 . . . DB, DW, N, OR NS PACKAGE  
(TOP VIEW)



SN54BCT574 . . . FK PACKAGE  
(TOP VIEW)



## description/ordering information

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops of the 'BCT574 devices are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels that were set up at the data (D) inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## ORDERING INFORMATION

| $T_A$          | PACKAGE†      |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|---------------|---------------|-----------------------|------------------|
| 0°C to 70°C    | PDIP – N      | Tube          | SN74BCT574N           | SN74BCT574N      |
|                | SOIC – DW     | Tube          | SN74BCT574DW          | BCT574           |
|                |               | Tape and reel | SN74BCT574DWR         |                  |
|                | SOP – NS      | Tape and reel | SN74BCT574NSR         | BCT574           |
| SSOP – DB      | Tape and reel | SN74BCT574DBR | BT574                 |                  |
| –55°C to 125°C | CDIP – J      | Tube          | SNJ54BCT574J          | SNJ54BCT574J     |
|                | CFP – W       | Tube          | SNJ54BCT574W          | SNJ54BCT574W     |
|                | LCCC – FK     | Tube          | SNJ54BCT574FK         | SNJ54BCT574FK    |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54BCT574, SN74BCT574 OCTAL TRANSPARENT D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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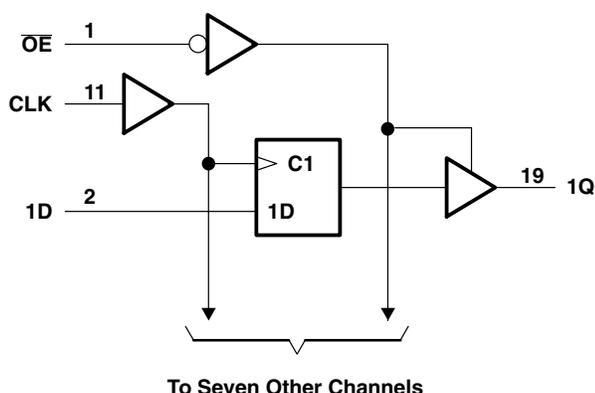
## description/ordering information (continued)

$\overline{OE}$  does not affect internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

FUNCTION TABLE  
(each flip-flop)

| INPUTS          |        |   | OUTPUT         |
|-----------------|--------|---|----------------|
| $\overline{OE}$ | CLK    | D | Q              |
| L               | ↑      | H | H              |
| L               | ↑      | L | L              |
| L               | H or L | X | Q <sub>0</sub> |
| H               | X      | X | Z              |

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|   |                    |
|---|--------------------|
| Supply voltage range, $V_{CC}$  | –0.5 V to 7 V      |
| Input voltage range, $V_I$ (see Note 1)                                       | –0.5 V to 7 V      |
| Voltage range applied to any output in the disabled or power-off state, $V_O$ | –0.5 V to 5.5 V    |
| Voltage range applied to any output in the high state, $V_{OH}$               | –0.5 V to $V_{CC}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                   | –30 mA             |
| Current into any output in the low state: SN54BCT574                          | 96 mA              |
| SN74BCT574  | 128 mA             |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package             | 70°C/W             |
| DW package  | 58°C/W             |
| N package   | 69°C/W             |
| NS package  | 60°C/W             |
| Storage temperature range, $T_{stg}$  | –65°C to 150°C     |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.



# SN54BCT574, SN74BCT574 OCTAL TRANSPARENT D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 3)

|          |                                | SN54BCT574 |     |     | SN74BCT574 |     |     | UNIT |
|----------|--------------------------------|------------|-----|-----|------------|-----|-----|------|
|          |                                | MIN        | NOM | MAX | MIN        | NOM | MAX |      |
| $V_{CC}$ | Supply voltage                 | 4.5        | 5   | 5.5 | 4.5        | 5   | 5.5 | V    |
| $V_{IH}$ | High-level input voltage       | 2          |     |     | 2          |     |     | V    |
| $V_{IL}$ | Low-level input voltage        |            |     | 0.8 |            |     | 0.8 | V    |
| $I_{IK}$ | Input clamp current            |            |     | -18 |            |     | -18 | mA   |
| $I_{OH}$ | High-level output current      |            |     | -12 |            |     | -15 | mA   |
| $I_{OL}$ | Low-level output current       |            |     | 48  |            |     | 64  | mA   |
| $T_A$    | Operating free-air temperature | -55        |     | 125 | 0          |     | 70  | °C   |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS           |  | SN54BCT574 |      | SN74BCT574 |      | UNIT |      |
|-------------------|---------------------------|--|------------|------|------------|------|------|------|
|                   |                           |  | MIN        | TYP† | MAX        | MIN  |      | TYP† |
| $V_{IK}$          | $V_{CC} = 4.5\text{ V}$ , | $I_I = -18\text{ mA}$                  |            |      | -1.2       |      | -1.2 | V    |
| $V_{OH}$          | $V_{CC} = 4.5\text{ V}$   | $I_{OH} = -3\text{ mA}$                | 2.4        | 3.3  | 2.4        | 3.3  | V    |      |
|                   |                           | $I_{OH} = -12\text{ mA}$               | 2          | 3.2  |            |      |      |      |
|                   |                           | $I_{OH} = -15\text{ mA}$               |            |      | 2          | 3.1  |      |      |
| $V_{OL}$          | $V_{CC} = 4.5\text{ V}$   | $I_{OL} = 48\text{ mA}$                |            | 0.38 | 0.55       |      | V    |      |
|                   |                           | $I_{OL} = 64\text{ mA}$                |            |      |            | 0.42 |      | 0.55 |
| $I_I$             | $V_{CC} = 5.5\text{ V}$ , | $V_I = 5.5\text{ V}$                   |            |      | 0.4        |      | 0.4  | mA   |
| $I_{IH}$          | $V_{CC} = 5.5\text{ V}$ , | $V_I = 2.7\text{ V}$                   |            |      | 20         |      | 20   | μA   |
| $I_{IL}$          | $V_{CC} = 5.5\text{ V}$ , | $V_I = 0.5\text{ V}$                   |            |      | -0.6       |      | -0.6 | mA   |
| $I_{OS}^\ddagger$ | $V_{CC} = 5.5\text{ V}$ , | $V_O = 0$                              | -100       |      | -225       | -100 | -225 | mA   |
| $I_{OZH}$         | $V_{CC} = 5.5\text{ V}$ , | $V_O = 2.7\text{ V}$                   |            |      | 50         |      | 50   | μA   |
| $I_{OZL}$         | $V_{CC} = 5.5\text{ V}$ , | $V_O = 0.5\text{ V}$                   |            |      | -50        |      | -50  | μA   |
| $I_{CCL}$         | $V_{CC} = 5.5\text{ V}$ , | Outputs open                           |            | 38.1 | 62         | 38.1 | 62   | mA   |
| $I_{CCH}$         | $V_{CC} = 5.5\text{ V}$ , | Outputs open                           |            | 4.9  | 8          | 4.9  | 8    | mA   |
| $I_{CCZ}$         | $V_{CC} = 5.5\text{ V}$ , | Outputs open                           |            | 4.5  | 8          | 4.9  | 8    | mA   |
| $C_i$             | $V_{CC} = 5\text{ V}$ ,   | $V_I = 2.5\text{ V}$ or $0.5\text{ V}$ |            |      |            | 5.5  |      | pF   |
| $C_o$             | $V_{CC} = 5\text{ V}$ ,   | $V_O = 2.5\text{ V}$ or $0.5\text{ V}$ |            |      |            | 7.5  |      | pF   |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

|                    |                                 | $V_{CC} = 5\text{ V}$ ,<br>$T_A = 25^\circ\text{C}$ |     | SN54BCT574 |     | SN74BCT574 |     | UNIT |
|--------------------|---------------------------------|---|-----|------------|-----|------------|-----|------|
|                    |                                 | MIN   | MAX | MIN        | MAX | MIN        | MAX |      |
| $f_{\text{clock}}$ | Clock frequency                 |   | 77  |            | 77  |            | 77  | MHz  |
| $t_w$              | Pulse duration, CLK high or low | 6.5   |     | 6.5        |     | 6.5        |     | ns   |
| $t_{\text{su}}$    | Setup time, data before CLK↑    | High  | 4.5 | 4.5        | 4.5 |            | ns  |      |
|                    |                                 | Low   | 6   | 6          | 6   |            |     |      |
| $t_h$              | Hold time, data after CLK↑      |   | 0   | 1          | 0   |            | ns  |      |



**SN54BCT574, SN74BCT574**  
**OCTAL TRANSPARENT D-TYPE FLIP-FLOPS**  
**WITH 3-STATE OUTPUTS**

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

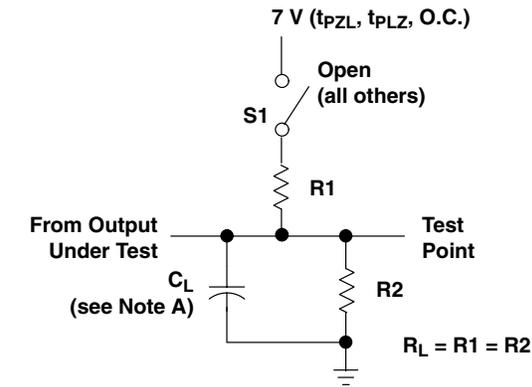
| PARAMETER | FROM (INPUT)    | TO (OUTPUT) | $V_{CC} = 5$ V,<br>$T_A = 25^\circ$ C |     |     | SN54BCT574 |      | SN74BCT574 |      | UNIT |
|-----------|-----------------|-------------|---------------------------------------|-----|-----|------------|------|------------|------|------|
|           |                 |             | MIN                                   | TYP | MAX | MIN        | MAX  | MIN        | MAX  |      |
| $f_{max}$ |                 |             | 77                                    |     |     | 77         |      | 77         |      | MHz  |
| $t_{PLH}$ | CLK             | Q           | 2.2                                   | 6.5 | 8.6 | 2.2        | 11.2 | 2.2        | 10   | ns   |
| $t_{PHL}$ |                 |             | 2.8                                   | 6.1 | 8   | 2.8        | 9.7  | 2.8        | 8.9  |      |
| $t_{PZH}$ | $\overline{OE}$ | Q           | 2.5                                   | 6.4 | 8.1 | 2.5        | 10.9 | 2.5        | 10.4 | ns   |
| $t_{PZL}$ |                 |             | 3.7                                   | 7.3 | 9.2 | 3.7        | 11.3 | 3.7        | 10.9 |      |
| $t_{PHZ}$ | $\overline{OE}$ | Q           | 1                                     | 4.4 | 7.4 | 1          | 8    | 1          | 7.5  | ns   |
| $t_{PLZ}$ |                 |             | 1.3                                   | 4.2 | 5.8 | 1.3        | 7.1  | 1.3        | 6.4  |      |



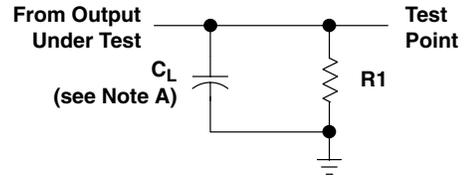
# SN54BCT574, SN74BCT574 OCTAL TRANSPARENT D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCBS074C – SEPTEMBER 1991 – REVISED MARCH 2003

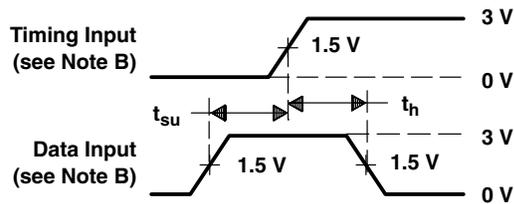
## PARAMETER MEASUREMENT INFORMATION



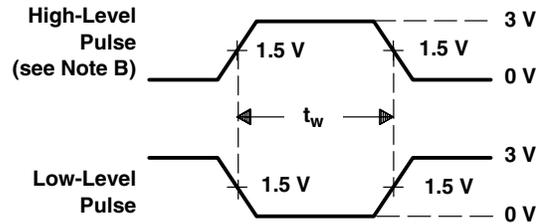
LOAD CIRCUIT FOR  
3-STATE AND OPEN-COLLECTOR OUTPUTS



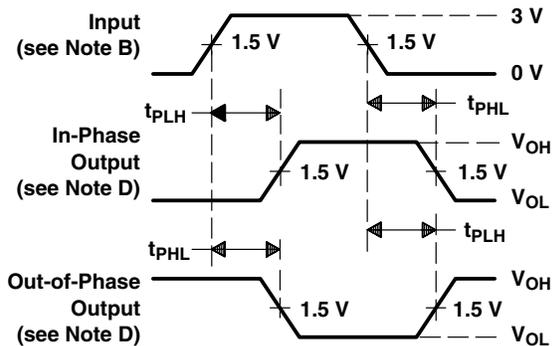
LOAD CIRCUIT FOR  
TOTEM-POLE OUTPUTS



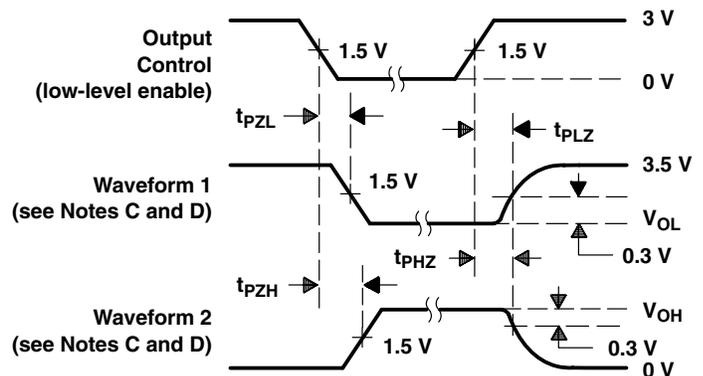
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES (see Note D)



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $t_r = t_f \leq 2.5$  ns, duty cycle = 50%.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - The outputs are measured one at a time with one transition per measurement.
  - When measuring propagation delay times of 3-state outputs, switch S1 is open.
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



**PACKAGING INFORMATION**

| Orderable part number           | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                 |
|---------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------------|
| <a href="#">5962-9583601QRA</a> | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9583601QR<br>A<br>SNJ54BCT574J |
| <a href="#">SN74BCT574DW</a>    | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT574                              |
| SN74BCT574DW.A                  | Active        | Production           | SOIC (DW)   20 | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | BCT574                              |
| <a href="#">SN74BCT574N</a>     | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN74BCT574N                         |
| SN74BCT574N.A                   | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN74BCT574N                         |
| <a href="#">SNJ54BCT574J</a>    | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9583601QR<br>A<br>SNJ54BCT574J |
| SNJ54BCT574J.A                  | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9583601QR<br>A<br>SNJ54BCT574J |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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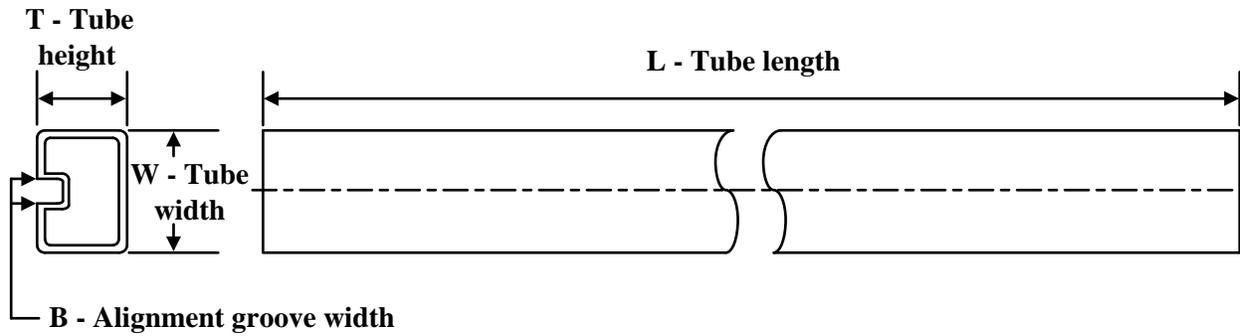
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54BCT574, SN74BCT574 :**

- Catalog : [SN74BCT574](#)
- Military : [SN54BCT574](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TUBE**


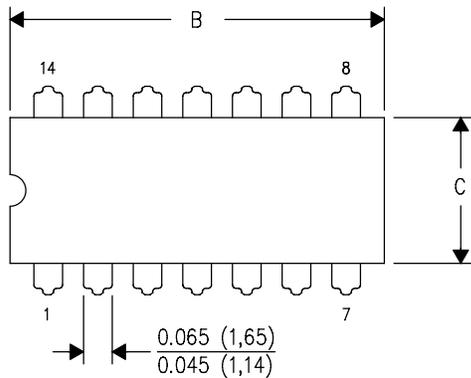
\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74BCT574DW   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74BCT574DW.A | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74BCT574N    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74BCT574N.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

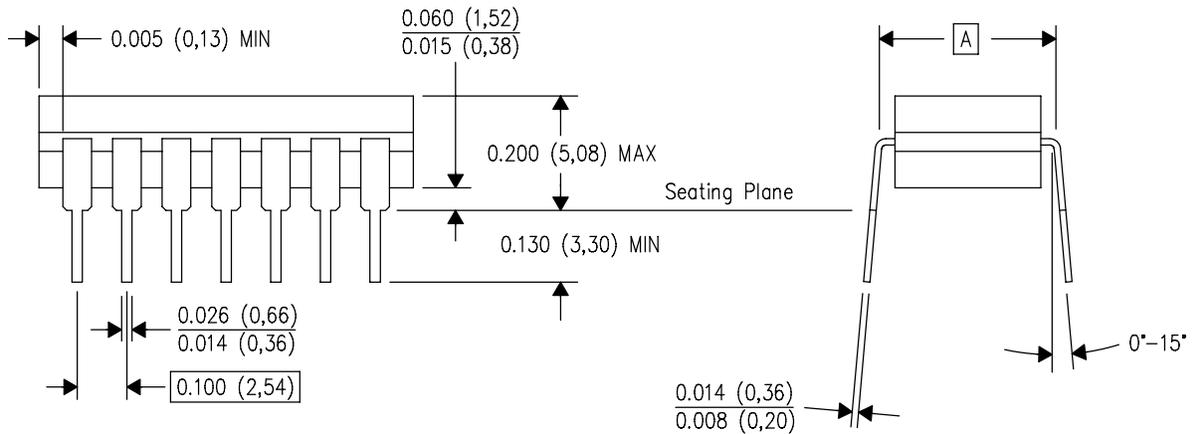
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

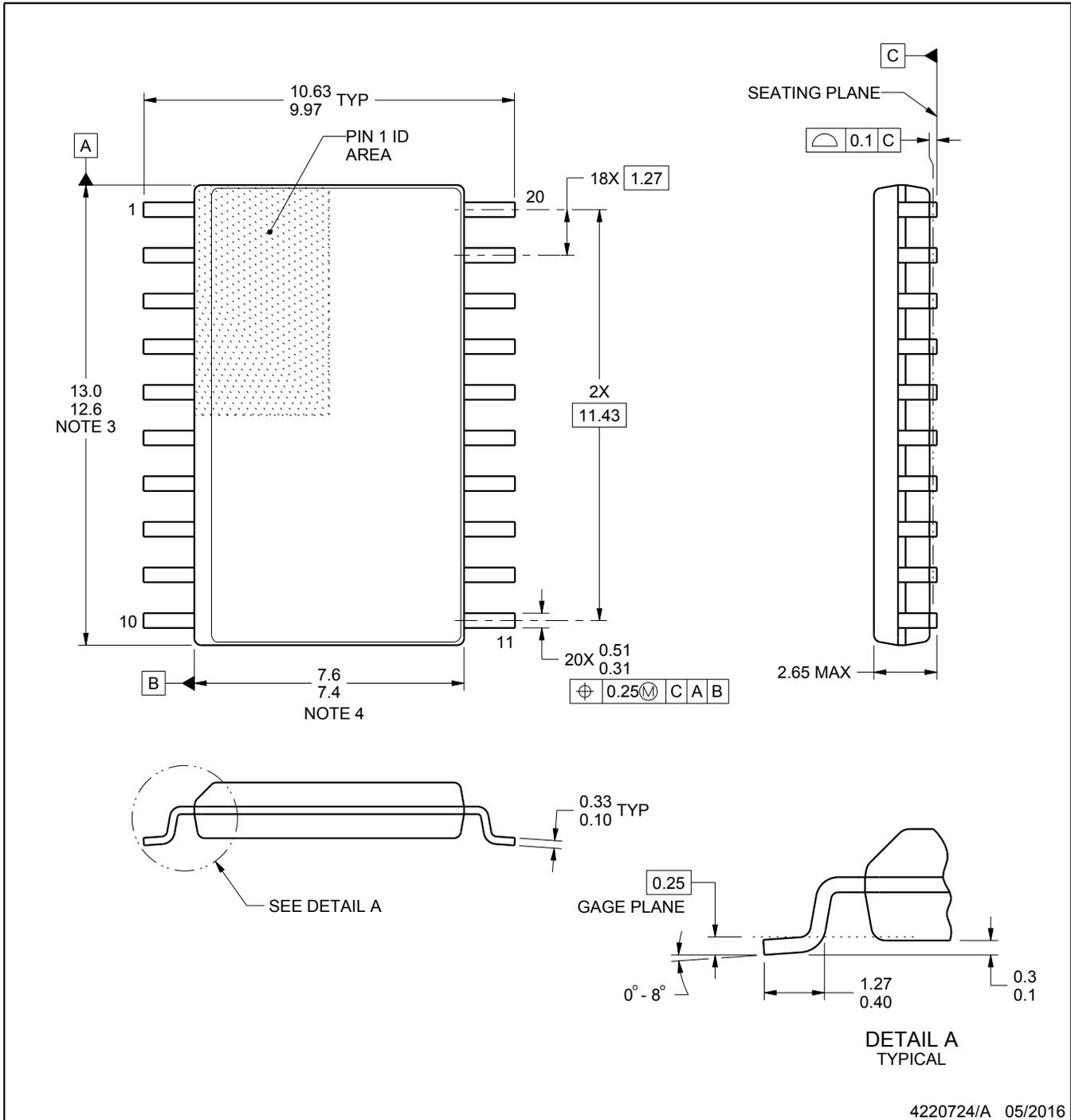
# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

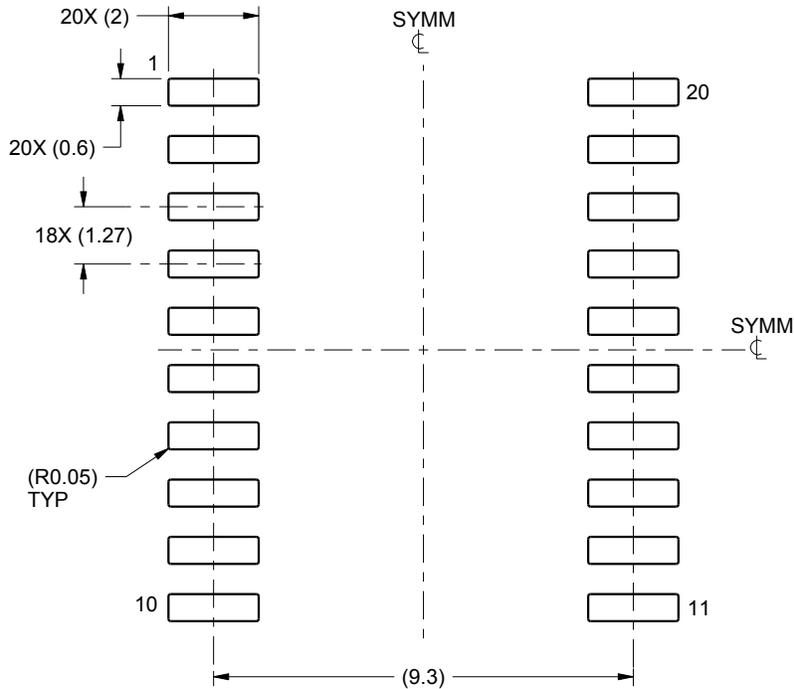
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

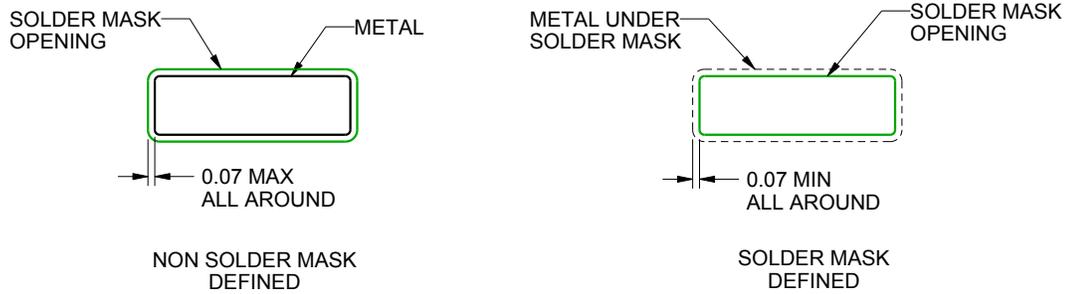
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

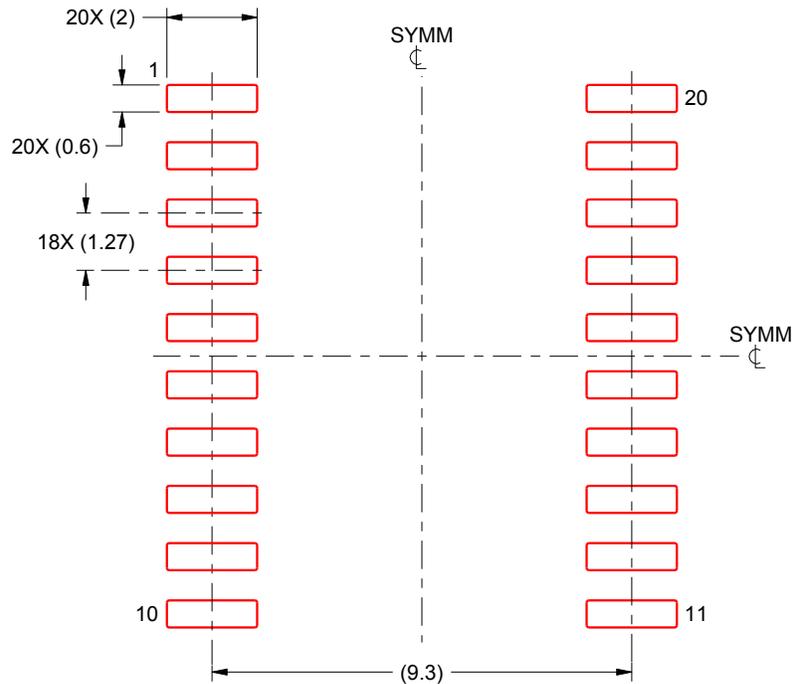
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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